PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Mitsuru Wakisaka	05/25/2010
Tatsunori Sakai	05/25/2010

RECEIVING PARTY DATA

Name:	Suzuki Motor Corporation	
Street Address:	300, Takatsuka-cho, Minami-ku	
Internal Address:	Hamamatsu-shi	
City:	Shizuoka-ken	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12722647

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Betty-Lou Rosser

Total Attachments: 1 source=Assn2#page1.tif

PATENT REEL: 024479 FRAME: 0293 CH \$40.00 127

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ASSIGNMENT

WHEREAS: Mitsuru WAKISAKA and Tatsunori SAKAI of c/o SUZUKI AUTO PARTS TOYAMA CO., LTD., 3200, Mizushima, Oyabe-shi, Toyama-ken, JAPAN (same for both of the inventors) (hereinafter referred to as ASSIGNOR), have invented and own a certain invention entitled: COLLAPSIBLE MOLD AND METHOD OF MANUFACTURING THE SAME

for which application for United States Letters Patent identified as <u>U.S. Appln. No. 12/722647 filed o</u> March 12, 2010 has been executed on the day of, 2010, and,
WHEREAS: SUZUKI MOTOR CORPORATION, a corporation duly organized under and pursuant to the law of JAPAN and having its principal place of business at 300, Takatsuka-cho, Minami-ku, Hamamatsu-shi Shizuoka-ken, JAPAN (hereinafter referred to as "ASSIGNEE"), has equitable rights in and to this invention and desires to confirm such rights and to acquire all right, title and interest in and to this invention, including any and all United States Letter Patent or similar legal protection to be obtained therefor.
NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby sells, assigns, and transfers to said ASSIGNEE, its successors and assigns, all right, title and interest in and to said invention including any and all United States Letters Patent which may be granted therefor and any and all extensions continuations, divisions, renewals, substitutes or reissues thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.
ASSIGNOR hereby covenants that no assignment, sale, agreement of encumbrance has been or will be made of entered into which would conflict with this assignment and sale.
ASSIGNOR further covenants and agrees, upon request, to execute any instrument which said ASSIGNEI desires to carry this assignment in effect, and perfect the title transferred hereby, or to file or prosecute any of the above-mentioned United States applications.
And the Commissioner of Patents of the United States is hereby authorized to issue Letters Patent on said above named application and on any continuation, substitute or division thereof to said ASSIGNEE.
IN TESTIMONY WHEREOF, I/We have hereunto set hand and seal this 25th day of May, 2010
ASSIGNOR:
<u>Mitsuru Wakisaka</u> Mitsuru WAKISAKA
Mitsuru WAKISAKA

Tatsunori SAKAI

PATENT REEL: 024479 FRAME: 0294

RECORDED: 06/03/2010